

CUSTOMER NO. 36257

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Wayne Glenn RENKEN et al.
Title: Integrated Process Condition Sensing Wafer and Data Analysis System
Application No.: 10/718,269 Filing Date: November 19, 2003
Examiner: Jermele M. HOLLINGTON Group Art Unit: 2829
Docket No.: SENS.008US3 Conf. No.: 9982

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO FINAL OFFICE ACTION AND STATEMENT OF INTERVIEW

Sir:

This is in response to the final Office Action dated February 8, 2006, setting a period for response expiring on May 8, 2006. An appropriate request for extension of time accompanies this paper.

Amendments to the Specification are not being made.

Amendments to the Claims begin on page 2 of this paper.

Amendments to the Drawings are not being made.

Remarks begin on page 7 of this paper.